



FAST RECOVERY SILICON RECTIFIERS

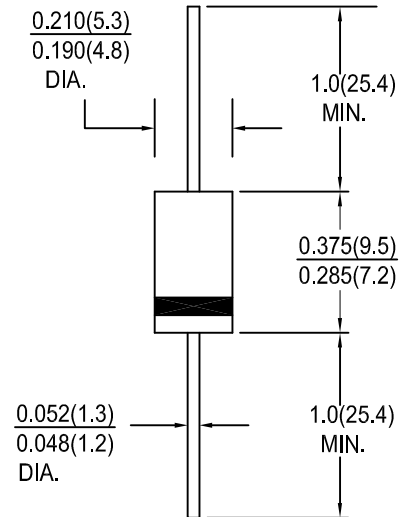
FEATURES:

- Low cost
- High surge current capability
- Low leakage current
- Low forward voltage drop
- Diffused junction

MECHANICAL DATA

Case : Molded plastic use UL 94V-0 recognized flame retardant epoxy
 Terminals : Axial leads, solderable per MIL-STD-202 Method 208 guaranteed
 Polarity : Color band on body denotes cathode
 Mounting Position : Any
 Weight : 1.1 grams, 0.039 ounce

DO-201AD



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25° C ambient temp. unless otherwise specified.
 Single phase, half sine wave, 60 Hz, resistive or inductive load.
 For capacitive load, derate current by 20 %.

Characteristic	Symbol	FR 301	FR 302	FR 303	FR 304	FR 305	FR 306	FR 307	Units	
Maximum recurrent peak reverse voltage	VRRM	50	100	200	400	600	800	1000	Volts	
Maximum RMS voltage	VRMS	35	70	140	280	420	560	700	Volts	
Maximum DC blocking voltage	VDC	50	100	200	400	600	800	1000	Volts	
Maximum average forward rectified current at Ta=55° C	IO	3.0							Amps	
Peak forward surge current ,8.3ms single half sine-wave superimposed on rated load(JEDEC Method)	IFSM	150.0							Amps	
Maximum instantaneous forward voltage drop at 3.0 A	VF	1.30							Volts	
Maximum DC reverse current at rated DC blocking voltage Ta=25° C Ta=55° C	IR	5.0 30.0							μ A	
Typical reverse recovery time (note 1)	trr	150	150	150	150	250	500	500	nS	
Typical junction capacitance (note 2)	Cj	60							pF	
Operating junction and storage temperature range	Tj, Tstg	-65 to +125				-65 to +150				° C

NOTES:1. Reverse recovery test condition; I_F=0.5A, I_R=1.0A, I_{RR}=0.25A
 2. Measured at 1MHz and Applied reverse voltage of 4.0V DC



RATINGS AND CHARACTERISTIC CURVES

FIG.1-DERATING CURVE FOR OUTPUT RECTIFIER CURRENT

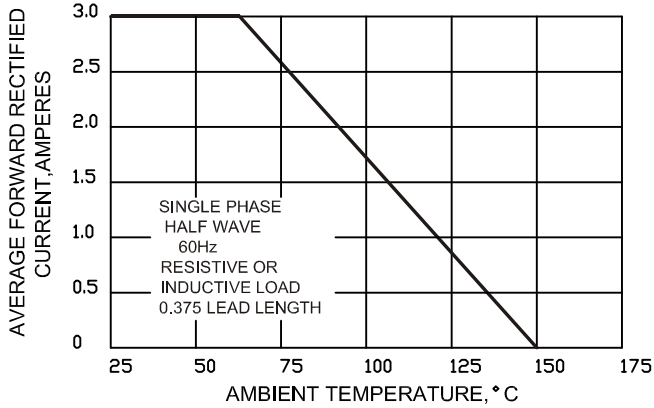


FIG.2-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

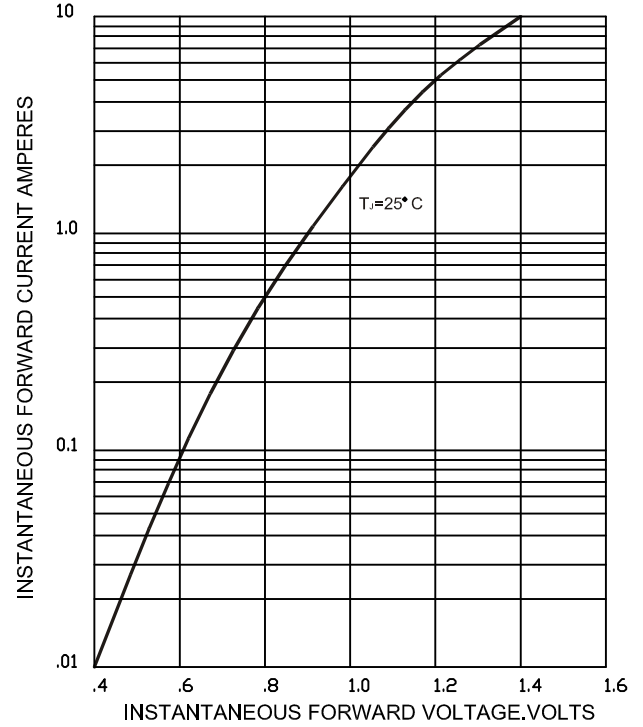


FIG.3-TYPICAL JUNCTION CAPACITANCE

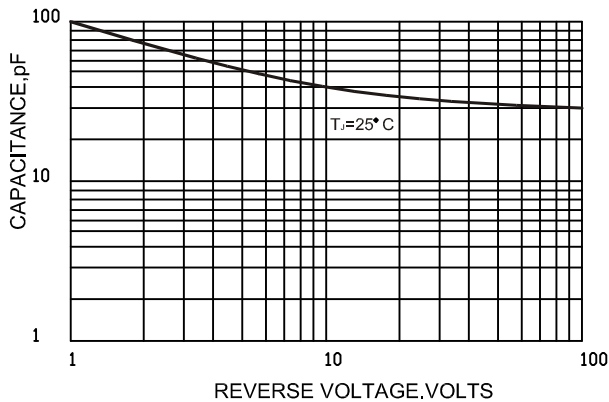


FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

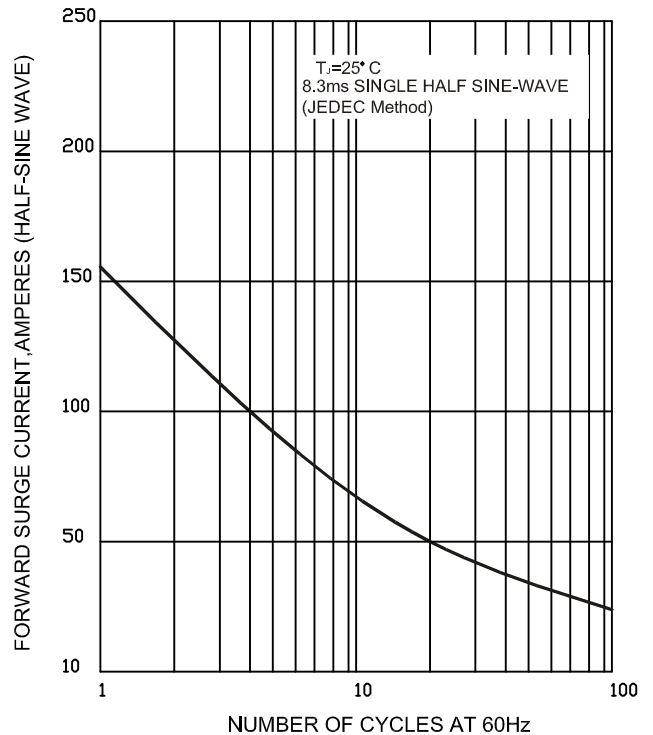
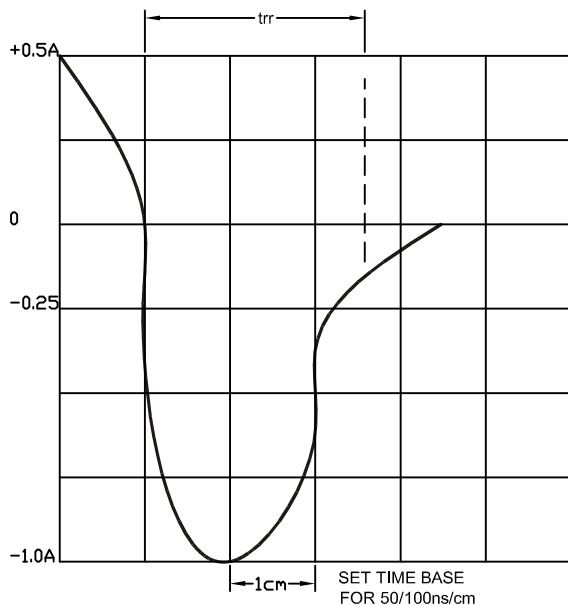


FIG.5-REVERSE RECOVERY TIME CHARACTERISTICS





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